

Appin No. 10/760,186

Amdt. Dated January 30, 2006

Response to Office Action of November 14, 2005

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Amendments to the Specification:**The paragraph beginning at page 9, line 7 to line 8 is to be amended as follows:**

The ink jet printhead chip 52 (see Fig. 6) includes a silicon wafer substrate 801~~5~~. 0.35 Micron 1 P4M 12 volt CMOS microprocessing circuitry is positioned on the silicon wafer substrate 801~~5~~.